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## Title of Invention

INTEGRATION OF BARRIER LAYER AND SEED LAYER

Application Number:

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First Named Applicant:

Mr. Chung Hua

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APPM6303

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Documents being submitted:	Files	
us-ids	APPM6303-usidst.xml	
	us-ids.dtd	
	us-ids.xsl	
us-fee-sheet	APPM6303-usfees.xml	
	us-fee-sheet.xsl	
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